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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10003375	FILING DATE 11/15/2001	CLASS 324	SUBCLASS 765.000	GAU 2862	EXAMINER Nguyen, Tung
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****APPLICANTS:** Ong Adrian; Englekemier Darren; Sprague Edward; Miller Alan;
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****CONTINUING DATA VERIFIED:**
THIS APPLN CLAIMS BENEFIT OF 60/279,416 03/28/2001
WHICH IS A CON OF 09/384,791 08/26/1999 PAT 6,195,237

****FOREIGN APPLICATIONS VERIFIED:**
ITALY MI2000A 002318 10/26/2000

PG-PUB DO NOT PUBLISH <input checked="" type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO M-9433 US
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	
Verified and Acknowledged Examiner's initials	
TITLE: Law of and use of bond pads and probe pads for testing of integrated circuits devices	

U.S. DEPT. OF COM. / PAT. & TM. PTO-132 (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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